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nut	AL	6-54749 w Eng. Abs.	3/2/89	Japan	HOIL	23/28		X		
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	AC	6,143,981	11.7/00	Glenn	174	52.4				
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A	AI	4,530,152	7/23/85	Roche, et al.	29	588				
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MH	AL	57-45959 w/Eng. Abs.	3/16/82	Japan	H01L	23/28				
1	AM	62-9639 w/Eng. Abs.	1/17/87	Japan	H01L	21/56	X			
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	AC	5,258,094	11/2/93	Furui, et al.	156	634		<u>-</u> ,		
	AD	5,278,446	1/11/94	Nagaraj, et al.	257	707				
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	AO	9-8205	1/10/97	Japan	H01L	23/50	X			
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<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Includes the Colombia of the Colombia of